

# PCIe® 3.0 Clock Generator with 2 HCSL Outputs

### **Features**

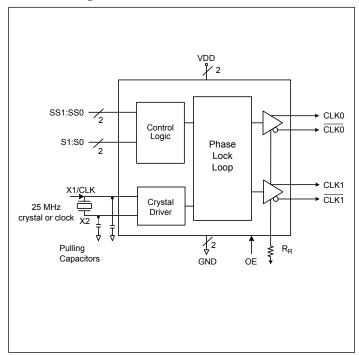
- → PCIe® 3.0 compliant
  - PCIe 3.0 Phase jitter 0.45ps RMS (High Freq. Typ.)
- → LVDS compatible outputs
- → Supply voltage of 3.3V ±10%
- → 25MHz crystal or clock input frequency
- → HCSL outputs, 0.8V Current mode differential pair
- → Jitter 35ps cycle-to-cycle (typ)
- → Spread of -0.5%, -0.75%, and no spread
- → Industrial temperature range
- → Spread Bypass option available
- → Spread and frequency selection via external pins
- → Packaging: (Pb-free and Green)
  - 16-pin TSSOP (L16)
  - 16-pin QSOP (Q16)

## **Description**

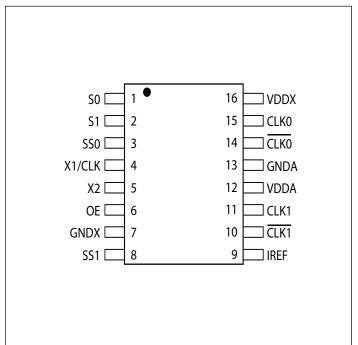
The PI6C557-03B is a spread spectrum clock generator compliant to PCI Express\* 3.0 and Ethernet requirements. The device is used for PC or embedded systems to substantially reduce Electromagnetic Interference (EMI).

The PI6C557-03B provides two differential (HCSL) or LVDS spread spectrum outputs. The PI6C557-03B is configured to select spread and clock selection. Using Pericom's patented Phase-Locked Loop (PLL) techniques, the device takes a 25MHz crystal input and produces two pairs of differential outputs (HCSL) at 25MHz, 100MHz, 125MHz and 200MHz clock frequencies. It also provides spread selection of -0.5%, -0.75%, and no spread.

## **Block Diagram**



# Pin Configuration (16-Pin TSSOP)





## **Pin Description**

Pin#	Pin Name	I/O Type	Description
1	S0	Input	Select pin 0 (Internal pull-up resistor). See Table 1.
2	S1	Input	Select pin 1 (Internal pull-up resistor). See Table 1.
3	SS0	Input	Spread Select pin 0 (Internal pull-up resistor). See Table 2.
4	X1/CLK	Input	Crystal or clock input. Connect to a 25MHz crystal or single ended clock.
5	X2	Output	Crystal connection. Leave unconnected for clock input.
6	OE	Input	Output enable. Internal pull-up resistor.
7	GNDX	Power	Crystal ground pin.
8	SS1	Input	Spread Select pin 1 (Internal pull-up resistor). See Table 2.
9	IREF	Output	Precision resistor attached to this pin is connected to the internal current reference.
10	CLK1	Output	HCSL compliment clock output
11	CLK1	Output	HCSL clock output
12	VDDA	Power	Connect to a +3.3V source.
13	GNDA	Power	Output and analog circuit ground.
14	CLK0	Output	HCSL compliment clock output
15	CLK0	Output	HCSL clock output
16	VDDX	Power	Connect to a +3.3V source.

**Table 1: Output Select Table** 

S1	S0	CLK(MHz)
0	0	25
0	1	100
1	0	125
1	1	200

**Table 2: Spread Selection Table** 

SS1	SS0	Spread
0	0	No Spread
0	1	Down -0.5
1	0	Down -0.75
1	1	No Spread

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## **Application Information**

### **Decoupling Capacitors**

Decoupling capacitors of 0.01  $\mu F$  should be connected between each  $V_{\rm DD}$  pin and the ground plane and placed as close to the  $V_{\rm DD}$  pin as possible.

### Crystal

Use a 25MHz fundamental mode parallel resonant crystal with less than 300PPM of error across temperature.

### **Crystal Capacitors**

 $C_L$  = Crystals's load capacitance in pF

Crystal Capacitors (pF) =  $(C_L - 8) *2$ 

For example, for a crystal with 16pF load caps, the external effective crystal cap would be 16 pF. (16-8)\*2=16.

### Current Source (IREF) Reference Resistor - RR

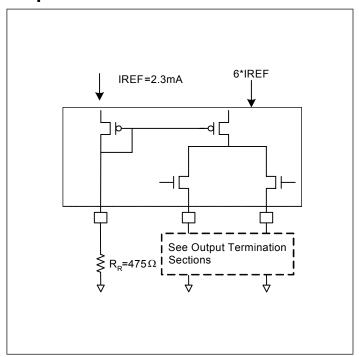
If board target trace impedance is  $50\Omega$ , then  $R_R=475\Omega$  providing an IREF of 2.32 mA. The output current ( $I_{OH}$ ) is 6\*IREF.

### **Output Termination**

The PCI Express differential clock outputs of the PI6C557-03B are open source drivers and require an external series resistor and a resistor to ground. These resistor values and their allowable locations are shown in detail in the PCI Express Layout Guidelines section.

The PI6C557-03B can be configured for LVDS compatible voltage levels. See the LVDS Compatible Layout Guidelines section.

## **Output Structures**



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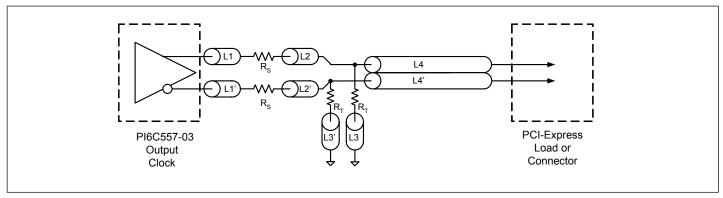
# **PCI Express Layout Guidelines**

Common Recommendations for Differential Routing	Dimension or Value	Unit
L1 length, route as non-coupled $50\Omega$ trace.	0.5 max	inch
L2 length, route as non-coupled $50\Omega$ trace.	0.2 max	inch
L3 length, route as non-coupled $50\Omega$ trace.	0.2 max	inch
$R_S$	33	Ω
$R_{\mathrm{T}}$	49.9	Ω

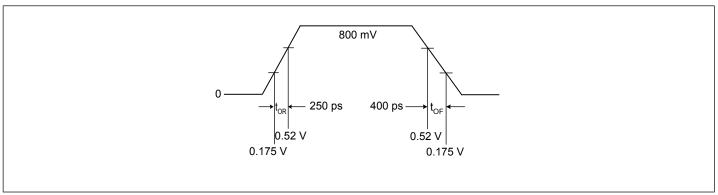
Differential Routing on a Single PCB	Dimension or Value	Unit
L4 length, route as coupled microstrip $100\Omega$ differential trace.	2 min to 16 max	inch
L4 length, route as coupled stripline $100\Omega$ differential trace.	1.8 min to 14.4 max	inch

Differential Routing to a PCI Express connector	Dimension or Value	Unit
L4 length, route as coupled microstrip $100\Omega$ differential trace.	0.25 min to 14 max	inch
L4 length, route as coupled stripline $100\Omega$ differential trace.	0.225 min to 12.6 max	inch

# **PCI Express Device Routing**



# Typical PCI Express (HCSL) Waveform

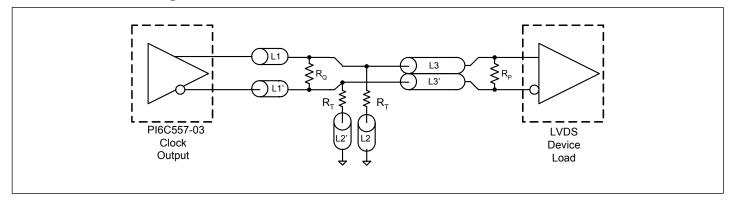




# **Application Information**

LVDS Recommendations for Differential Routing	Dimension or Value	Unit
L1 length, route as non-coupled $50\Omega$ trace.	0.5 max	inch
L2 length, route as non-coupled $50\Omega$ trace.	0.2 max	inch
RP	100	Ω
RQ	100	Ω
RT	150	Ω
L3 length, route as $100\Omega$ differential trace.		
L3 length, route as $100\Omega$ differential trace.		

# **LVDS Device Routing**



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## **Maximum Ratings**

(Above which useful life may be impaired. For user guidelines, not tested.)

Complex Weltage to Consumal Determinal F. E.V.	
Supply Voltage to Ground Potential 5.5V	
All Inputs and Outputs0.5V to V <sub>DD</sub> +0.5V	
Ambient Operating Temperature40 to +85°C	
Storage Temperature65 to +150°C	
Junction Temperature	
Soldering Temperature	
EDS Protection (Input)	

### Note:

Stresses greater than those listed under MAXI-MUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## **Electrical Specifications**

### **Recommended Operation Conditions**

Parameter	Min.	Тур.	Max.	Unit
Ambient Operating Temperature	-40		+85	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+3.6	V

## DC Characteristics ( $V_{DD} = 3.3V \pm 10\%$ , $T_A = -40$ °C to +85°C)

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
$V_{\mathrm{DD}}$	Supply Voltage			3.0	3.3	3.6	V
V <sub>IH</sub>	Input High Voltage(1)	OE, S0, S1, SS0, S	SS1	2.0		V <sub>DD</sub> +0.3	V
$V_{\rm IL}$	Input Low Voltage <sup>(1)</sup>	OE, S0, S1, SS0, S	SS1	GND -0.3		0.8	V
		0 . 17	With input pull-up and pull-downs	-20		20	
I <sub>IL</sub>	Input Leakage Current	$0 < Vin < V_{DD}$	Without input pull-up and pull-downs	-5		5	μΑ
$I_{DD}$	Operating Supply Cur-	$R_{L} = 50\Omega, C_{L} = 2$	pF			95	mA
$I_{DDOE}$	rent	OE = LOW				50	mA
C <sub>IN</sub>	Input Capacitance	@ 55MHz	@ 55MHz			7	pF
Cout	Output Capacitance	@ 55MHz				6	pF
L <sub>PIN</sub>	Pin Inductance					5	nH
R <sub>OUT</sub>	Output Resistance	CLK Outputs		3.0			kΩ

#### Notes:

1. Single edge is monotonic when transitioning through region.

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## HCSL Output AC Characteristics ( $V_{DD} = 3.3V \pm 10\%$ , $T_A = -40$ °C to +85°C)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
F <sub>IN</sub>	Input Frequency			25		MHz
V <sub>OUT</sub>	Output Frequency		25		200	MHz
V <sub>OH</sub>	Output High Voltage (1,2)	100 MHz HCSL output @ $V_{DD}$ = 3.3V	660	800	900	mV
V <sub>OL</sub>	Output Low Voltage(1,2)		-150	0		mV
V <sub>CPA</sub>	Crossing Point Voltage <sup>(1,2)</sup>	Absolute	250	350	550	mV
V <sub>CN</sub>	Crossing Point Voltage(1,2,4)	Variation over all edges			140	mV
Jcc	Jitter, Cycle-to-Cycle <sup>(1,3)</sup>			35	60	ps
J <sub>RMS2.0</sub>	PCIe 2.0 RMS Jitter	PCIe 2.0 Test Method @ 100MHz Output			3.1	ps
	PCIe 3.0 RMS Jitter	PLL L-BW @ 2M & 5M 1st H3		1.75	3	ps
I		PLL L-BW @ 2M & 4M 1st H3		2.18	3	ps
J <sub>RMS3.0</sub>		PLL H-BW @ 2M & 5M 1st H3		0.45	1	ps
		PLL H-BW @ 2M & 4M 1st H3		0.45	1	ps
MF	Modulation Frequency	Spread Spectrum	30	31.5	33	kHz
tor	Rise Time <sup>(1,2)</sup>	From 0.175V to 0.525V	175		700	ps
toF	Fall Time <sup>(1,2)</sup>	From 0.525V to 0.175V	175		700	ps
T <sub>SKEW</sub>	Skew between outputs	At Crossing Point Voltage			50	ps
T <sub>DUTY-CYCLE</sub>	Duty Cycle <sup>(1,3)</sup>		45		55	%
T <sub>OE</sub>	Output Enable Time <sup>(5)</sup>	All outputs			10	μs
T <sub>OT</sub>	Output Disable Time <sup>(5)</sup>	All outputs			10	μs
t <sub>STABLE</sub>	From power-up to V <sub>DD</sub> =3.3V	From Power-up V <sub>DD</sub> =3.3V		3.0		ms
t <sub>SPREAD</sub>	Setting period after spread change	Setting period after spread change		3.0		ms

## **Notes:**

- 1.  $R_L = 50$ -Ohm with  $C_L = 2 pF$
- 2. Single-ended waveform
- 3. Differential waveform
- 4. Measured at the crossing point
- 5. CLK pins are tri-stated when OE is LOW

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#### Thermal Characteristics

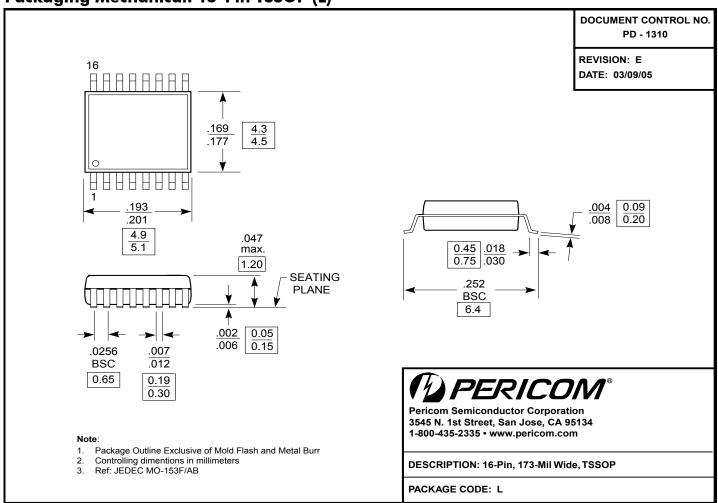
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$\theta_{JA}$	Thermal Resistance Junction to Ambient	Still air			90	°C/W
$\theta_{JC}$	Thermal Resistance Junction to Case				24	°C/W

### **Recomended Crystal Specification**

Pericom recommends:

- a) GC2500003 XTAL 49S/SMD(4.0 mm), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/GC\_GE.pdf
- b) FY2500081, SMD 5x3.2(4P), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/FY\_F9.pdf
- c) FL2500047, SMD 3.2x2.5(4P), 25M, CL=18pF, +/-20ppm http://www.pericom.com/pdf/datasheets/se/FL.pdf

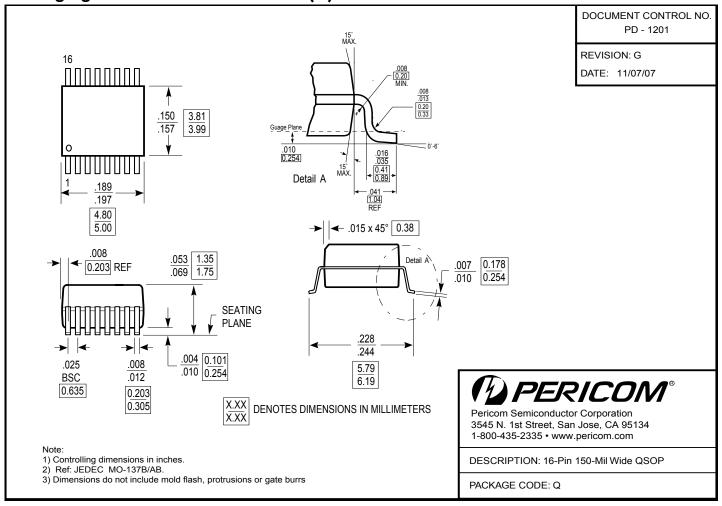
## Packaging Mechanical: 16-Pin TSSOP (L)



Note: For latest package info, please check: http://www.pericom.com/products/packaging/mechanicals.php



## Packaging Mechanical: 16-Pin QSOP (Q)



 $Note: For \ latest\ package\ info,\ please\ check:\ http://www.pericom.com/products/packaging/mechanicals.php$ 

# **Ordering Information**

Ordering Code	Package Code	Package Type
PI6C557-03BLE	L	Pb-free & Green, 16-pin TSSOP
PI6C557-03BQE	Q	Pb-free & Green, 16-pin QSOP

#### Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- "E" denotes Pb-free and Green
- Adding an "X" at the end of the ordering code denotes tape and reel packaging

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达尔科技)